

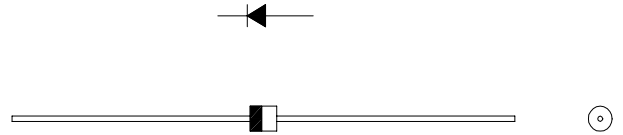
DIODE Type : 10EDB40

1A 400V Tj =150 °C

OUTLINE DRAWING

FEATURES

- * Miniature Size
- * Low Forward Voltage drop
- * Low Reverse Leakage Current
- * High Surge Capability
- * 26mm and 52mm Inside Tape Spacing Package Available



Maximum Ratings

Approx Net Weight:0.17g

Rating	Symbol	10EDB40			Unit	
Repetitive Peak Reverse Voltage	V _{RRM}	400			V	
Average Rectified Output Current	I _O	50Hz Half Sine Wave Resistive Load	Ta=39°C *1	1.0	A	
			Ta=26°C *2	0.9		
RMS Forward Current	I _{F(RMS)}				1.57	A
Surge Forward Current	I _{FSM}	50Hz Half Sine Wave,1cycle, Non-repetitive			45	A
Operating JunctionTemperature Range	T _{jw}	- 40 to + 150			°C	
Storage Temperature Range	T _{stg}	- 40 to + 150			°C	

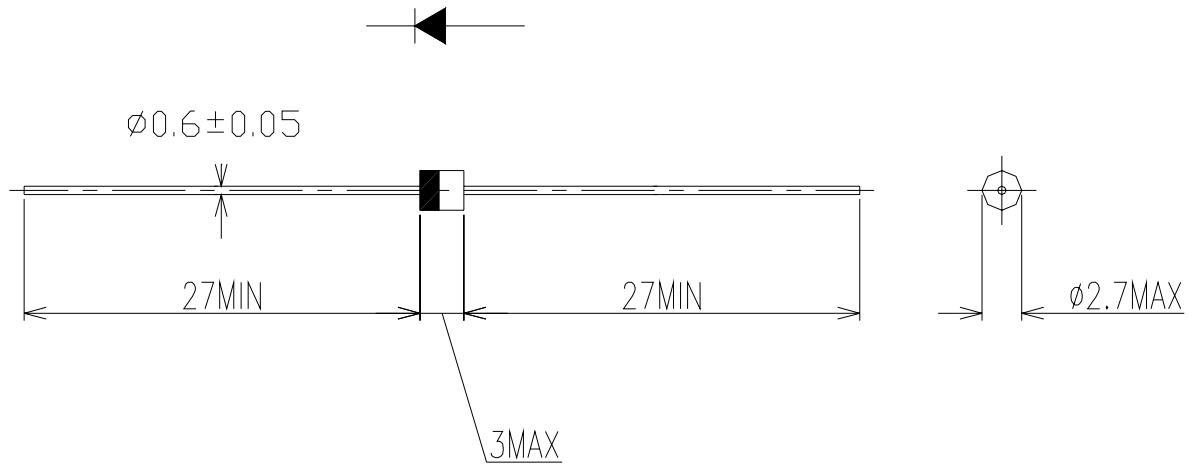
Electrical • Thermal Characteristics

Characteristics	Symbol	Conditions	Min.	Typ.	Max.	Unit
Peak Reverse Current	I_{RM}	Tj= 25°C, $V_{RM}= V_{RRM}$	-	-	10	μA
Peak Forward Voltage	V_{FM}	Tj= 25°C, $I_{FM}= 1.0A$	-	-	1.0	V
Thermal Resistance	$R_{th(j-a)}$	Junction to P.C. Board mounted*1	-	-	110	°C/W
		Ambient Without Fin *2	-	-	140	

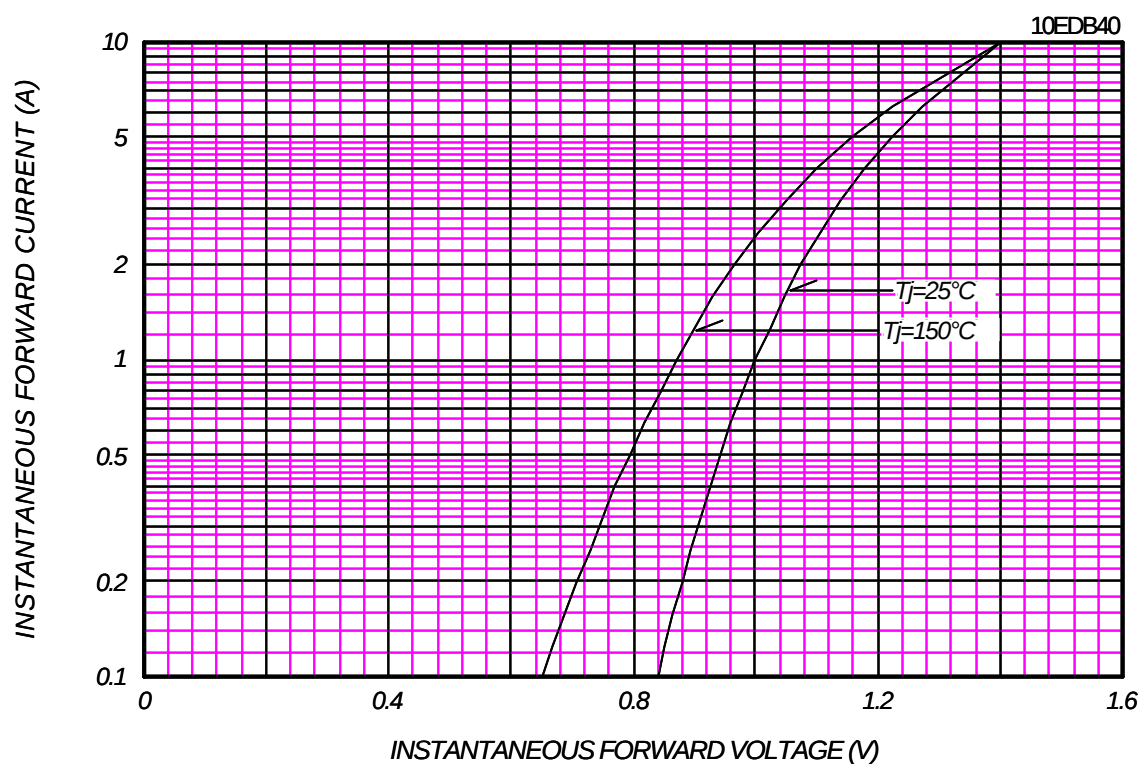
*1: P.C. Board mounted (L=3mm, Print Land=5 x 5mm, Both Sides)

*2: Without Fin or P.C. Board mounted

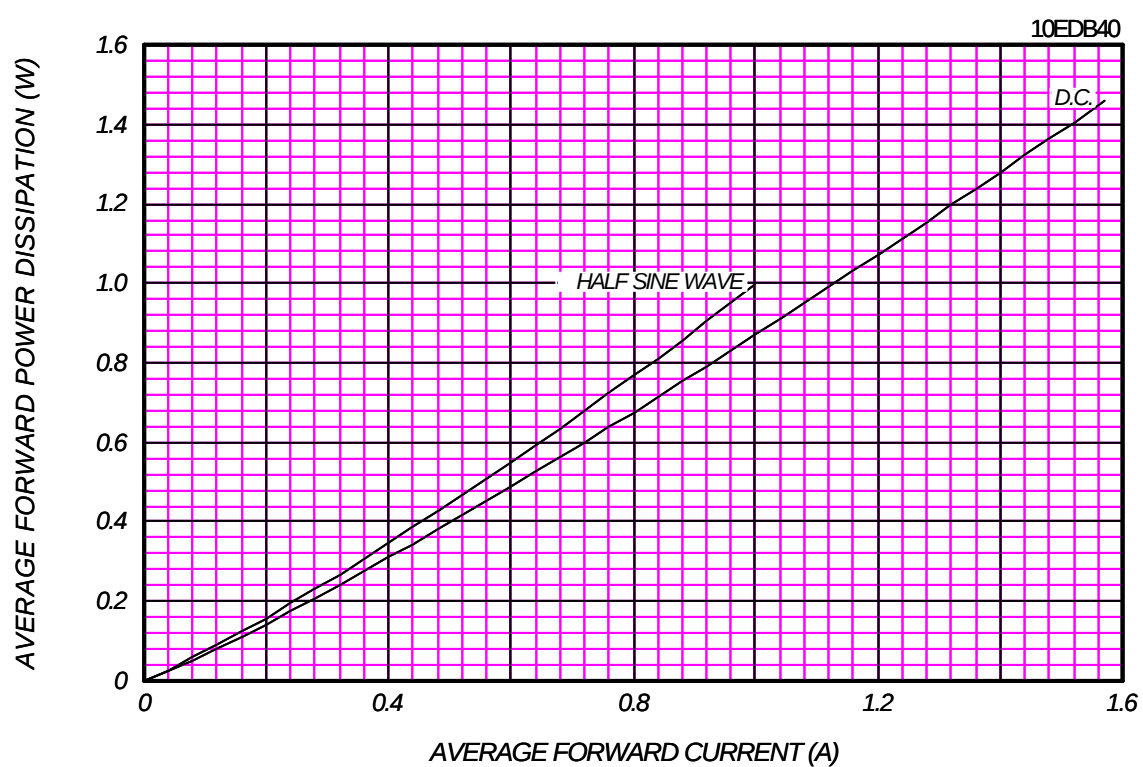
10EDB OUTLINE DRAWING (Dimensions in mm)



FORWARD CURRENT VS. VOLTAGE

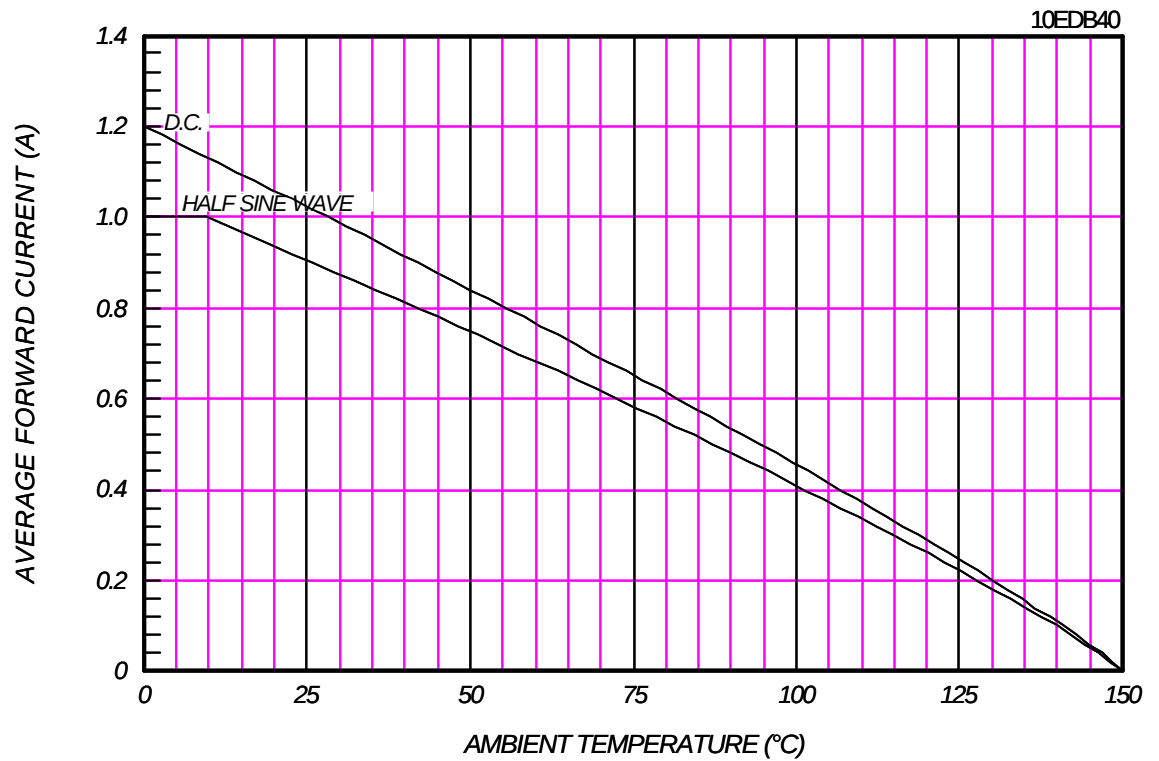


AVERAGE FORWARD POWER DISSIPATION



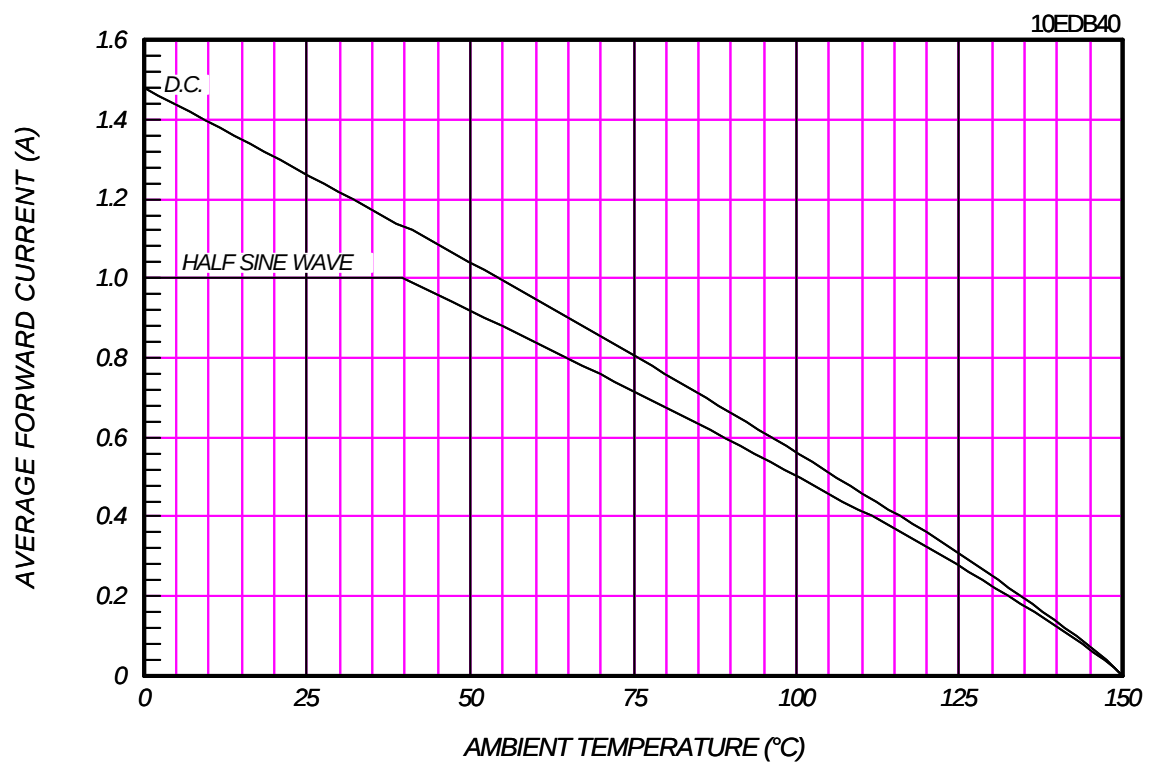
AVERAGE FORWARD CURRENT VS. AMBIENT TEMPERATURE

Without Fin or P.C. Board



AVERAGE FORWARD CURRENT VS. AMBIENT TEMPERATURE

P.C. Board mounted (L=3mm,Print Land=5×5mm,Both Sides))



SURGE CURRENT RATINGS

f=50Hz, Half Sine Wave, Non-Repetitive, No Load

10EDB40

